### **TI** Developer Conference

February 28-March 2, 2006 • Dallas, TX

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Accelerating Innovation with the DaVinci<sup>™</sup> Software Code and Programming Model

SEE THE FUTURE

Raj Pawate Distinguished Member Technical Staff Software Applications Manager Houston, Texas

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### TI Developer Conference Agenda

### Introduction

- Bare deck Silicon to Silicon with Component SW
- Challenges to building a Video Product

### What software content does TI provide?

- Codecs, drivers (Functionality)
- Abstraction (easy to use, plumbing, infrastructure)

### What is the Software Architecture?

- How are the different software components related?
- What is the programming model?

### Details of the three layers

- Application layer (APL)
- Input-Output layer (IOL)
- Signal Processing layer (SPL)
- TI Software Product Portfolio for DM6446/3
- Conclusion

### TI Developer Conference Acronyms

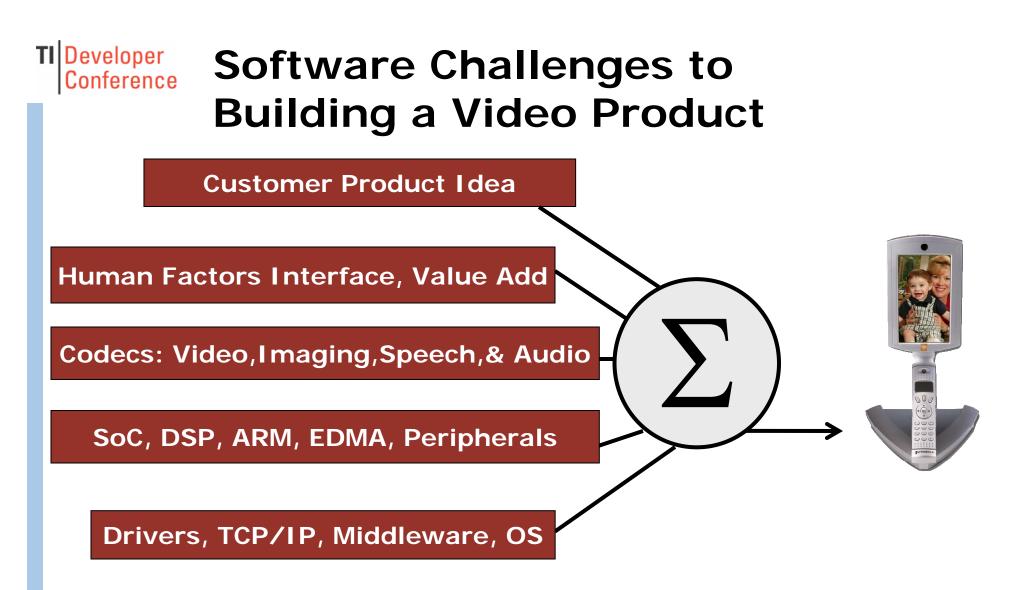
- **API** Application Programming Interface
- **APL** Application Layer
- **EPSI** Easy Peripheral Software Interface
- **HWAL** Hardware Adaptation Layer
- IOL Input-output Layer
- **OSAL** Operating System Adaptation Layer
- **RPC** Remote Procedure Call
- **SPL** Signal Processing Layer
- VISA Video, Imaging, Speech and Audio
- **xDM** xDAIS for Digital Media

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# Transitioning from Bare-deck Silicon to Silicon with Component SW

	Silicon	Silcon + SW
Device	$\checkmark$	$\checkmark$
EVM	$\checkmark$	$\checkmark$
Tools	$\checkmark$	$\checkmark$
Pretested Component-ware (windows, walls)		$\checkmark$
Drivers		$\checkmark$
Codecs		$\checkmark$
Pretested subsystem-ware (floor plans)		$\checkmark$
Codec combos		$\checkmark$
Integrated drivers in OS		$\checkmark$
Ease of Use and Rules (building codes)		$\checkmark$
Rules for replacing components		$\checkmark$
APIs, Framework (Abstraction ware)		$\checkmark$

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- Requires expertise in a variety of different domains
- Several man years to have a hardened codebase

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#### **TI** Developer **Goal: Accelerate Time to Market** Conference Standard multi-media product development New **Product Create SW Foundation Product Idea** Differentiation The DaVinci Effect Leverage **Product DaVinci ŠW** ifferentiation **Foundation**

Shorter development cycle and/or



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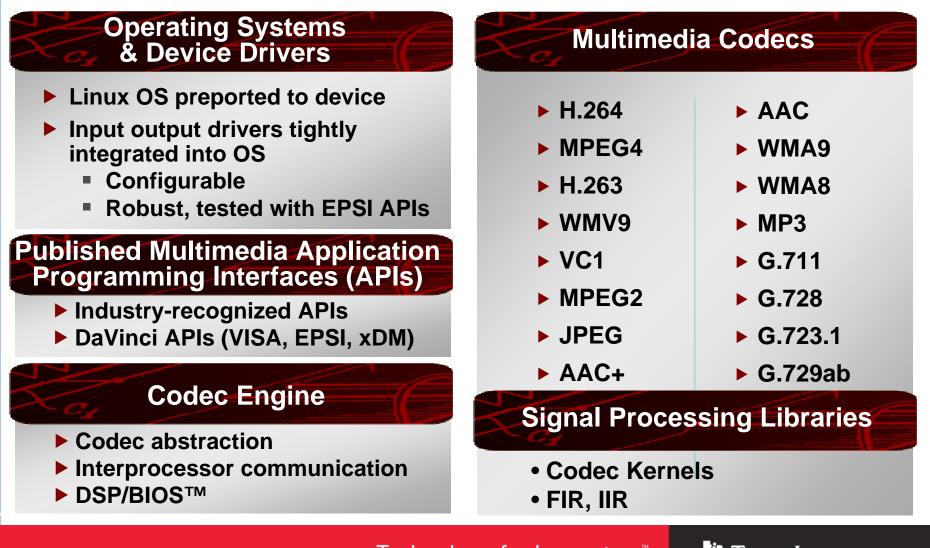
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## DaVinci<sup>™</sup> Software Offerings Optimized for Efficient Innovation



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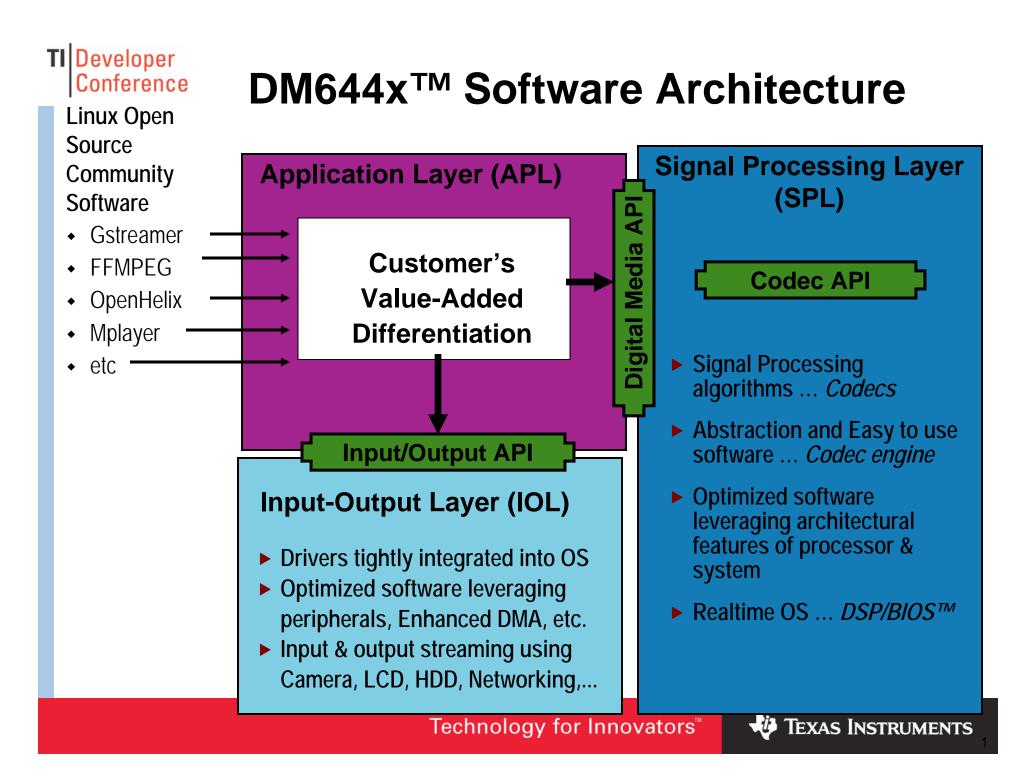
Texas Instruments

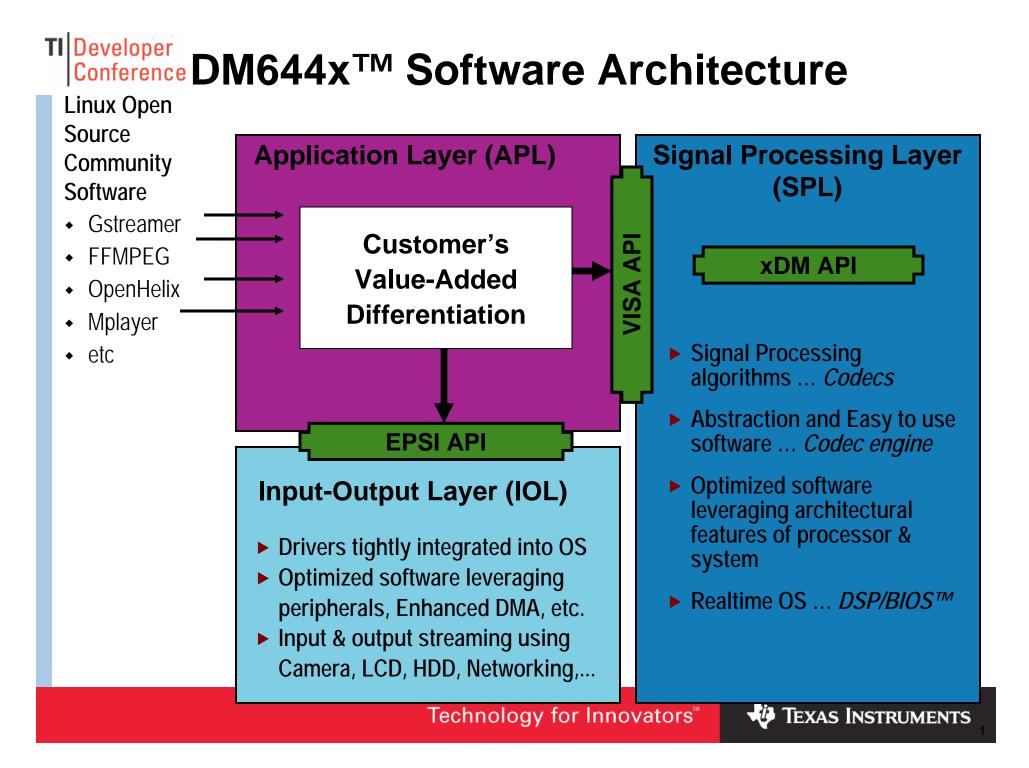
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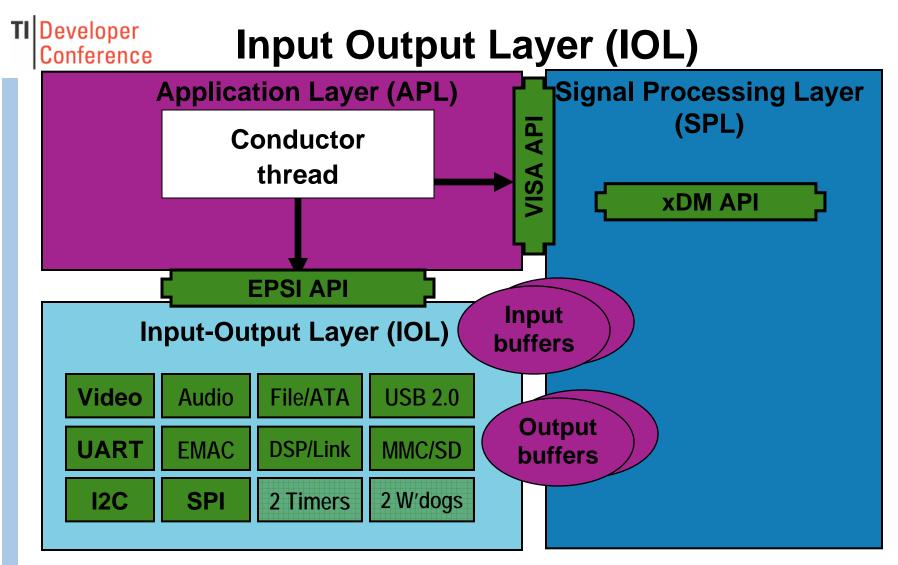
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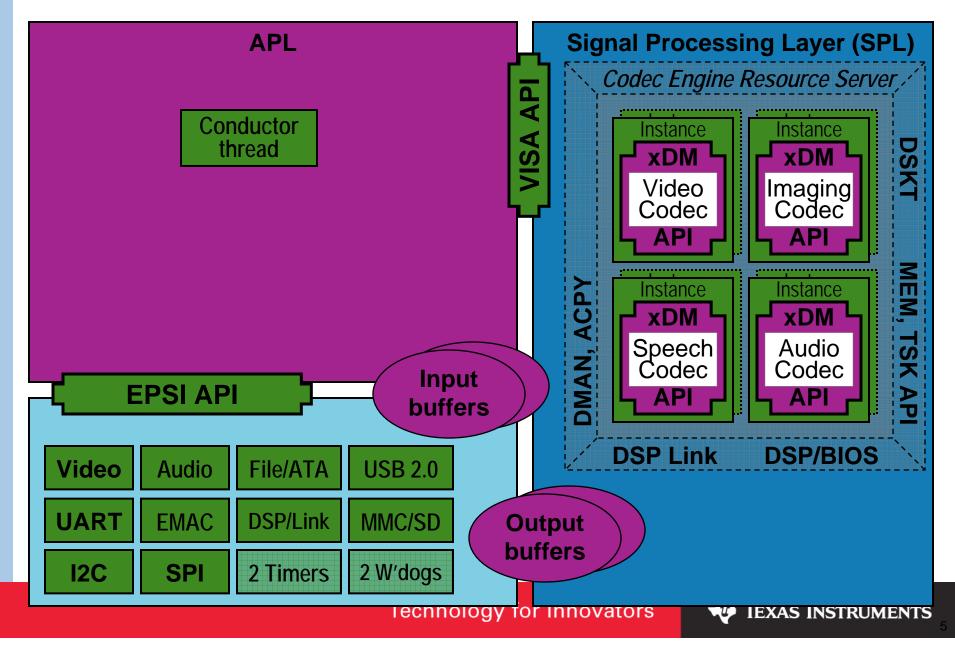
EPSI APIs: open read write close Linux APIs....V4L2 for Video, OSS for Audio, Speech, ... No overhead in passing buffers... only pointers are passed Optimized, robust (tested) drivers leveraging SoC features, EDMA, etc

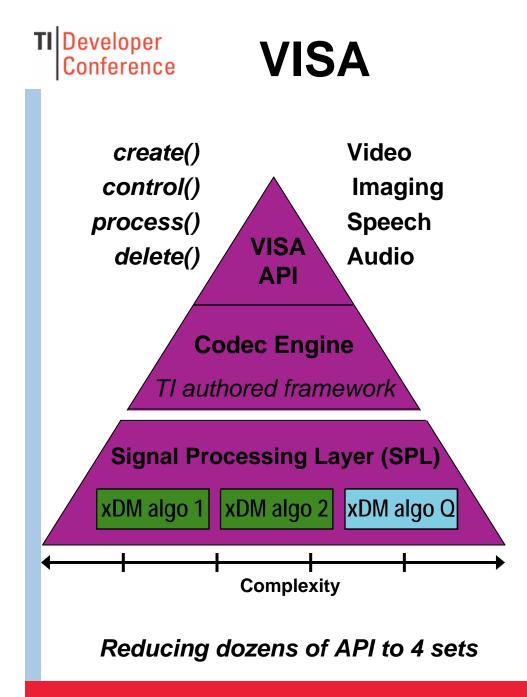
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# Signal Processing Layer (SPL)

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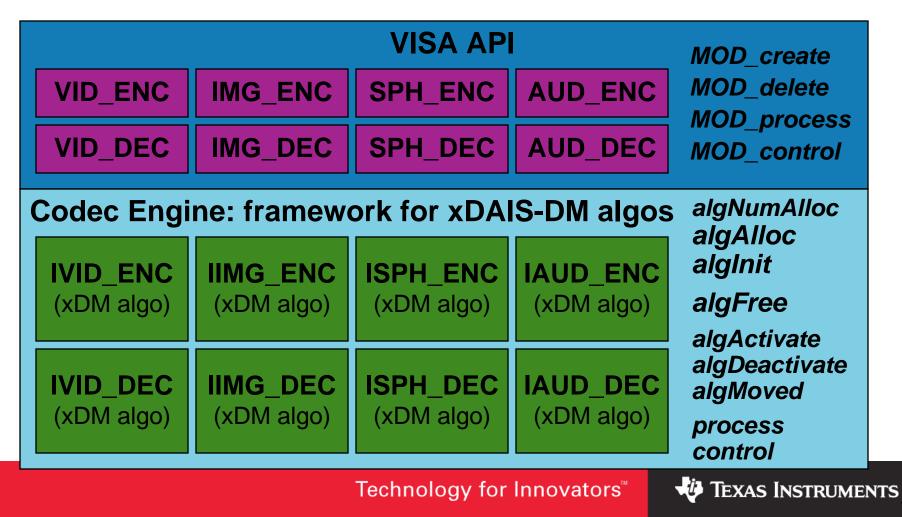
- Complexities of the Signal Processing Layer "SPL" are abstracted via the Codec Engine and VISA API
- VISA API are the user interface to the Codec Engine
- VISA = 4 processing domains :
  Video Imaging Speech Audio
- Separate API set for encode and decode
- Thus, a total of 8 API classes:
  VIDENC IMGENC SPHENC AUDENC
  VIDDEC IMGDEC SPHDEC AUDDEC
- Key API in each set (where "xxx" is one of the groups above):

xxx_create	xxx_delete
xxx_process	$xxx\_control$

 The experienced DSP programmer can employ a ready-made Signal Processing Layer, create an SPL from packaged or 'raw' xDM algos, or author their own algos depending on their needs and skills with DSP

#### TI Developer Conference VISA Abstracts Details of xDM Algos

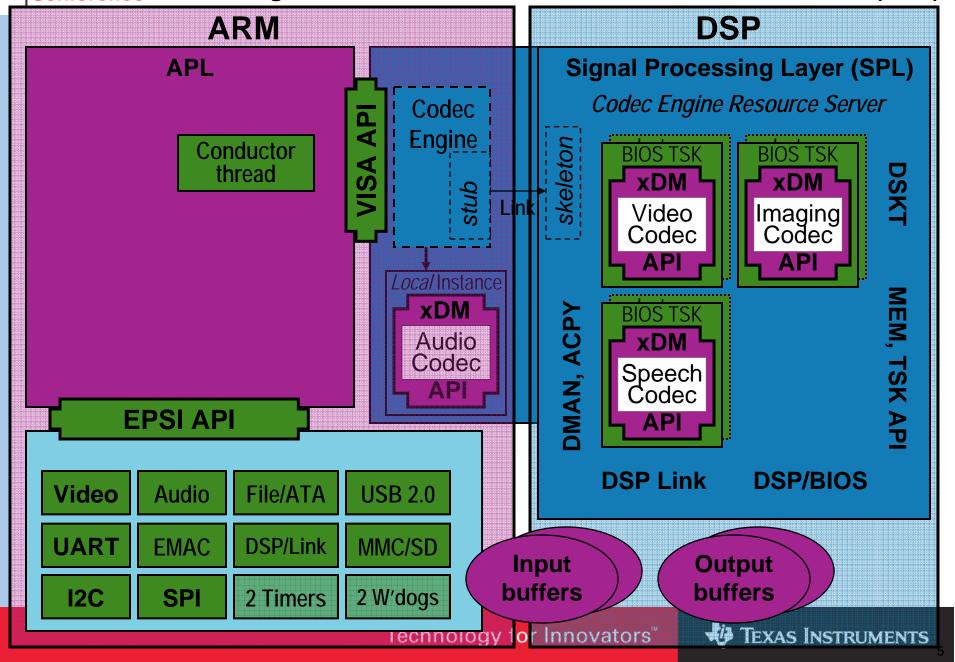
- Application author controls algos via high level VISA API
- xDAIS-DM (xDM) algorithms implement an enhanced xDAIS interface
- Codec Engine is a *framework* that implements VISA fxns on xDM algos
  - *eg*: MOD\_create() = algNumAlloc() + algAlloc() + MEM\_alloc() + algInit()



Mapping Software to Hardware:

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**Crossing Processor boundaries w/- Remote Procedure Calls (RPC)** 



### TI Developer Conference VISA Benefits

### **Application Author Benefits**

- App author enjoys benefits of signal processing layer without need to comprehend the complexities of the DSP algo or underlying hardware
- Application author uses only *one* API for a given media engine class
- Changing codec within the class involves *no* changes to app level code
- All media engine classes have a similar look and feel
- Adapting any app code to other engines and API is very straight forward
- Example apps that use VISA to manage xDM codecs provided by TI
- Customers can create multimedia frameworks that will leverage VISA API
- VISA contains hooks allowing additional functionalities within codecs
- Authoring app code, multimedia frameworks & end equipment expertise is what customers do best, and want to focus on - VISA optimizes this

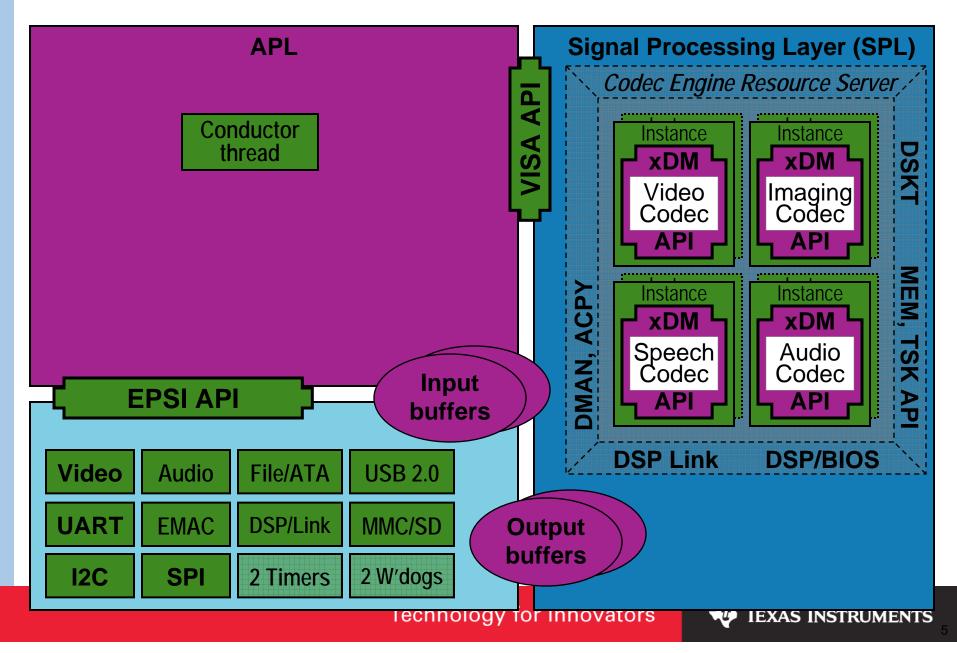
### Algorithm Author Benefits

- Codec engine authors have a known standard to write to
- Codec authors need have no knowledge of the end application
- Codecs can be sold more readily, since they are easy to apply widely
- Each class contains the information necessary for that type of media
- VISA, and xDAIS-DM, build on xDAIS an established algo interface
- Tools exist today to adapt algos to xDAIS, and may include –DM soon (?)

# **Application Layer (APL)**

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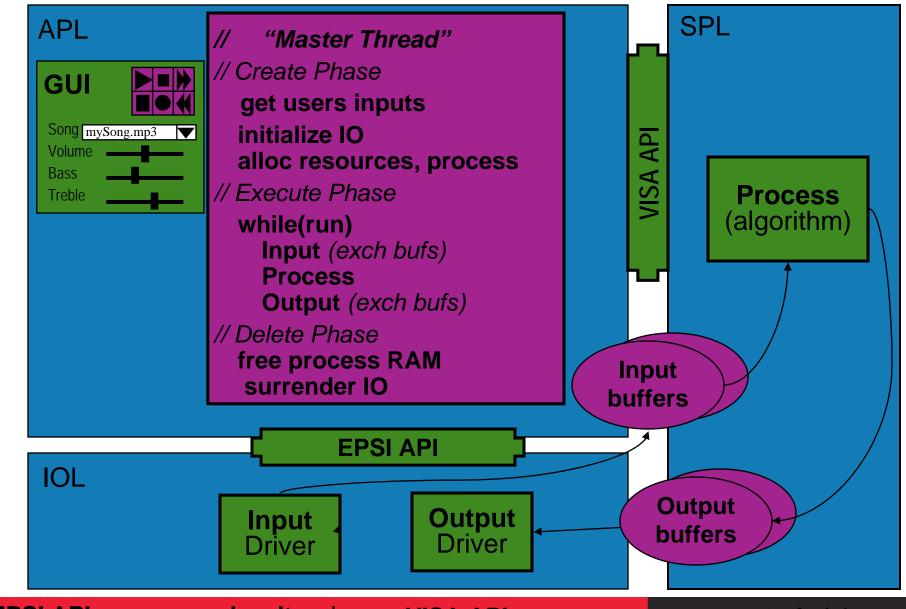
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### **APL Conductor Thread**

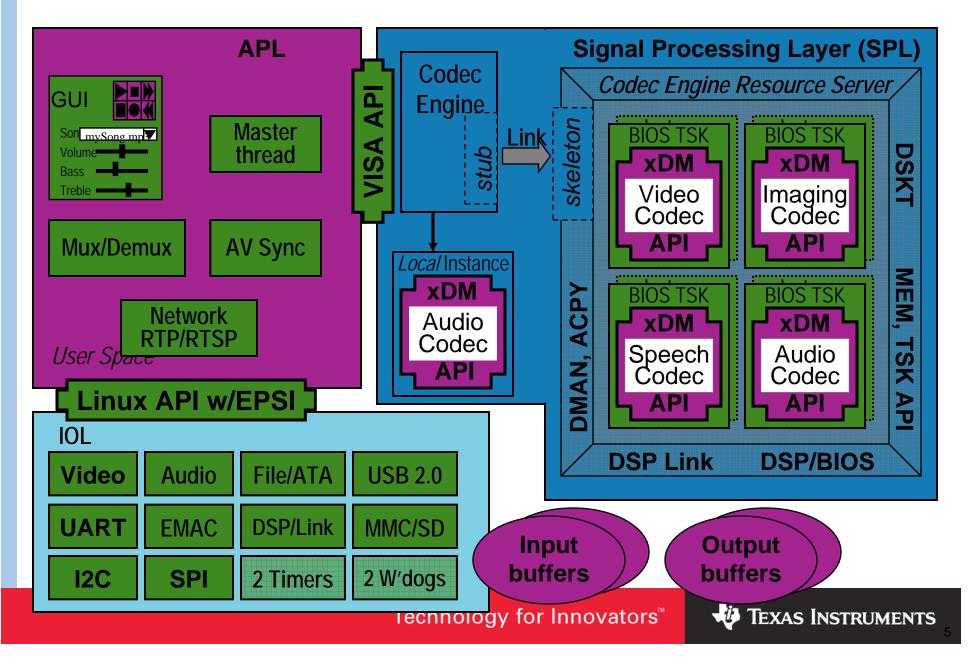
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EPSI APIs: open read write close NISA APIs: creaters recess Texas Instruments

### TI Developer Conference DaVinci Software Architecture on DM6446



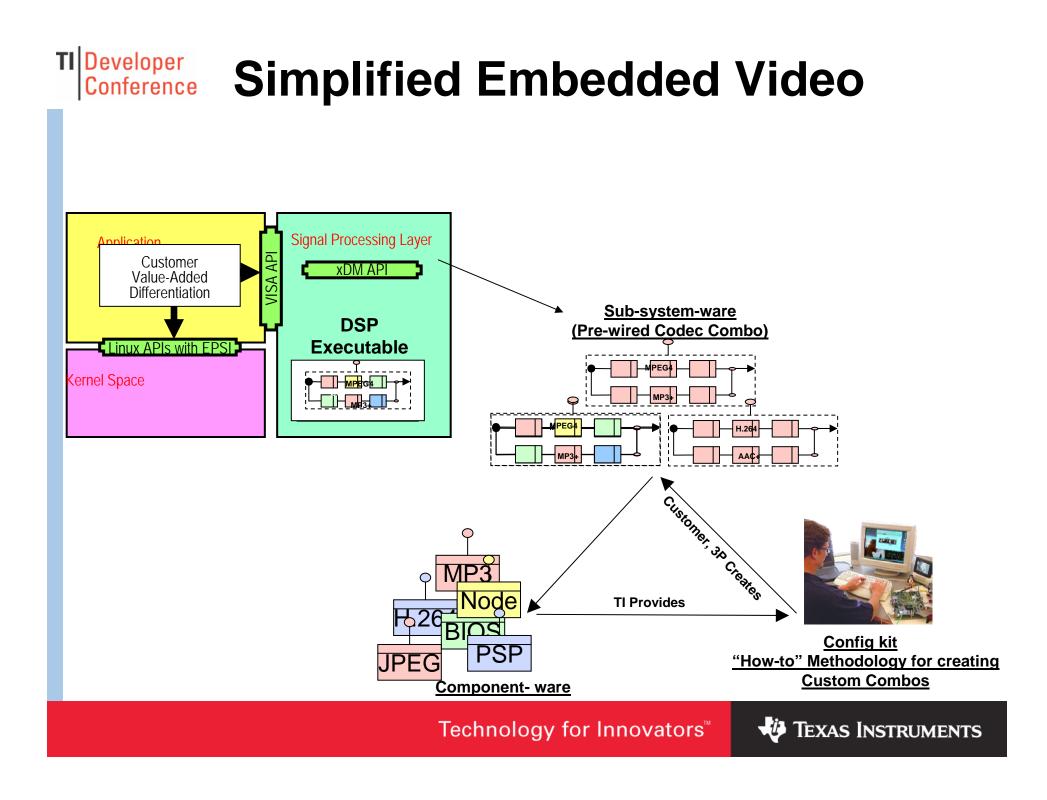
# **DaVinci Programmers Model**

- Three layers ... Application layer, IO layer, and Signal Processing layer
- Signal Processing layer

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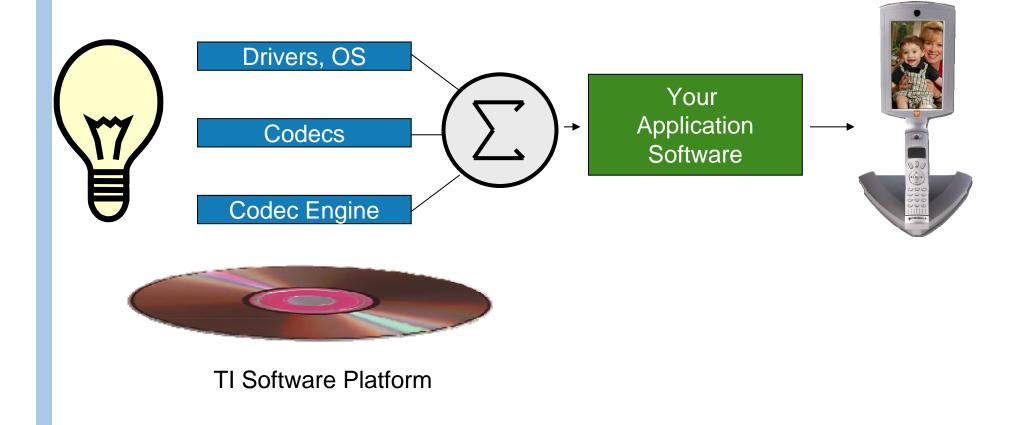
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- presents VISA APIs to all other layers
- implement codecs using xDM APIs,
- implements all other algorithms using xDAIS APIs
- buffer based processing, decoupled from all other layers
- delivered as
  - .lib for uniprocessor SoCs,
  - .out for multiprocessor SoCs
- Input output layer
  - presents EPSI APIs to all other layers
  - implements peripheral drivers
  - generates an interrupt to APL whenever a buffer is full
  - buffers in shared memory, only pointers are passed
- Application layer
  - implements the conductor thread, GUI, middleware,etc.
  - orchestrates all input and output streams to other layers
  - interfaces with the other layers as <u>built-in library functions</u>





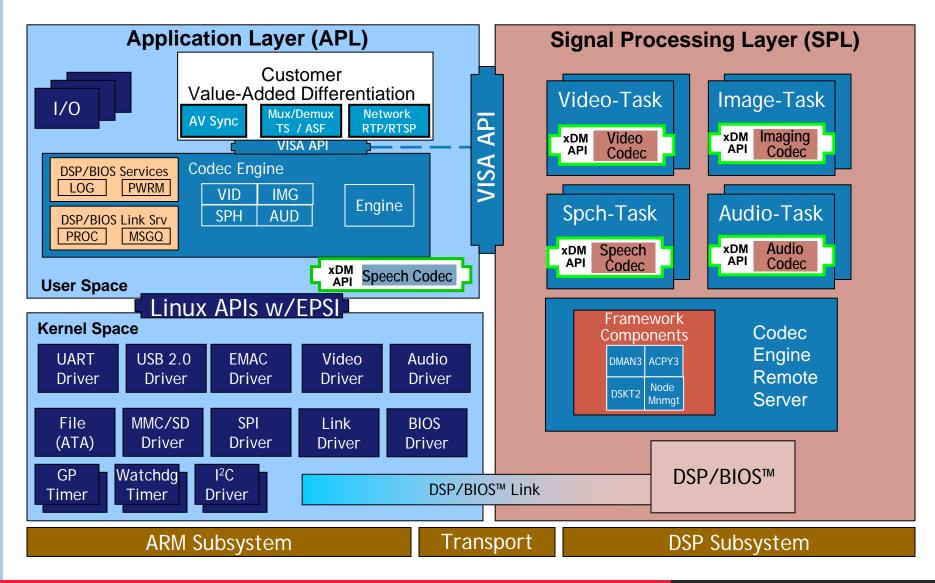
### **Conclusion: Accelerating Video Innovation From Idea to Realization**



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### TI Developer Conference DM644x<sup>™</sup> Software Stack



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